

**FEE TRANSMITTAL**

Electronic Version v08

Stylesheet Version v08.0

**Title of  
Invention**

[BUMP LAYOUT ON SILICON CHIP]

Application Number :

Date :

First Named Applicant: Mr. Wen-Chih Yang

Attorney Docket Number: 7808-US-PA-1

**TOTAL FEE AUTHORIZED \$ 770**

Patent fees are subject to annual revisions on or about October 1st of each year.

Filing as large entity

**BASIC FILING FEE**

Fee Description	Fee Code	Amount \$	Fee Paid \$
Utility Filing Fee	1001	770	770
Subtotal For Basic Filing Fees: \$ 770			

**EXTRA CLAIM FEES**

Fee Description	Extra Claim	Fee Code	Amount \$	Fee Paid \$
Total Claims : 6	0	1202	18	0
Independent Claims : 1	0	1201	88	0
Subtotal For Extra Claims Fees: \$ 0				

**AUTHORIZED BILLING INFORMATION****The commissioner is hereby authorized to charge indicated fees and credit any overpayments to:**

Credit account number: 1000  
Expiration Date (YYYYMMDD): 2006-10-31  
Authorized name: LEE, HUAI-LU  
Billing address: 99999